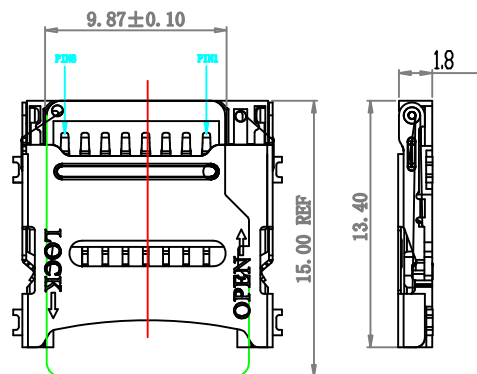
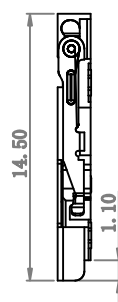


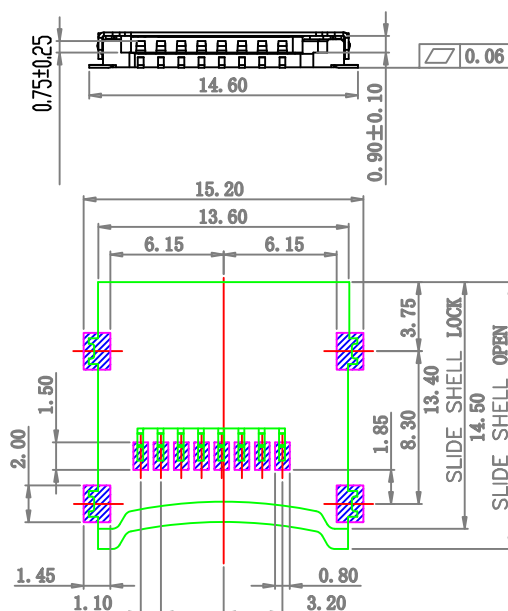
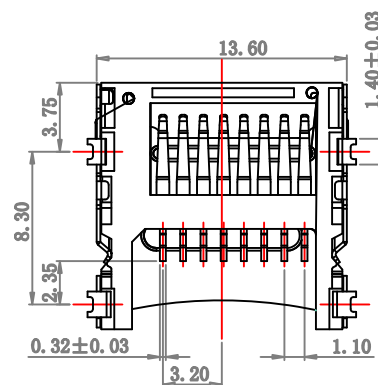
更改 REV	数量 MODIFICATION
A	ECN03889
B	ECN03915
C	ECN03923
D	ECN03930
E	ECN04243
F	ECN04866



SLIDE SHELL OPEN



SLIDE SHELL LOCK



RECOMMEND PCB LAYOUT
TOLERANCE: ± 0.05
TOP VIEW

PIN5	CLK		
PIN4	VDD		
PIN3	CMD	PIN8	DAT1
PIN2	CD/DAT3	PIN7	DAT0
PIN1	DAT2	PIN6	VSS
PIN NO.		PIN NO.	

MATERIALS

- HOUSING : THERMOPLASTIC LCP S475+30%GF, UL94 V-0.
- TERMINAL : COPPER ALLOY, C5191R-EH, T=0.15mm.
PLATING : 3u"AU PLATED ON CONTACT AREA,
80u"~120u" PLATED ON SOLDER TAILS,
50U"~80U"NICKEL PLATED OVERALL.
- SHELL : SUS304-1/2H , T=0.20mm.
- SOLDER : C5191R-EH , T=0.15mm.
PLATING : 80u"~120u" PLATED ON SOLDER TAILS,
50U"~80U"NICKEL PLATED OVERALL.

SPECIFICATION

- CURRENT RATING : 0.5 A. MAX.
- VOLTAGE RATING:5V.
- DIELECTRIC WITHSTANDING VOLTAGE :
250V AC R.M.S. FOR 1 MINUTE.
- INSULATION RESISTANCE : 500MΩ MIN. AT 5V DC.
- CONTACT RESISTANCE : 100mΩ MAX.
- OPERATING TEMPERATURE : -20° C TO +85° C.
- DURABILITY:5000 CYCLES.

Bill Of Materials:

No.	TITLE	MATERIAL	FINISH(OR COLOR)	QT'Y
1	HOUSING	LCP S475+30%GF, UL94 V-0	黑色	1
2	SHELL	SUS 304-1/2H	清洗除油(不电镀)	1
3	TERMINAL	C5191R-EH	接触点镀金3u", 焊脚镀锡80u"~120u"	1SET
4	SOLDER	C5191R-EH	锡膏 80u"~120u"	1SET

GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司	
X± 0.50	X*± 5 °	名 称(TITLE) Micro SD & T-Flash CONNECTOR HINGE TYPE	
.X± 0.30	.X*± 2 °		
.XX± 0.20	.XX*± 1 °		
单位(UNIT) mm	料 号(PART NO.) 7MSDH-F0-1012	图 号(DWG NO.) 7MSDH-F0-1012	张 数 1/1
审核(APPROVAL)	核 对(CHECKED)	製 图(DRAWN)	SCALE 1:1
			张 数 1/1
			更 改 REV F

